

## **KBJ10005 THRU KBJ1010**

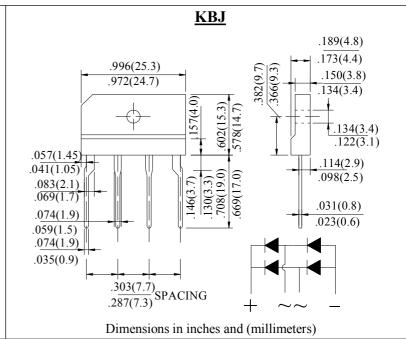
# PINGWEIENTERPRISE SINGLE PHASE 10.0 AMPS. GLASS PASSIVATED BRIDGE RECTIFIERS

#### **FEATURE**

- . Ideal for printed circuit board
- . Glass passivated chip junctions
- . High case dielectric strength
- . Low leakage
- . Low forward voltage
- . High surge current capability
- . High temperature soldering guaranteed:  $260^{\circ}$ C/10seconds/.375°,(9.5mm) lead lengths.

#### MECHANICAL DATA

- . Case: Molded plastic body
- . Epoxy: UL 94V-0 rate flame retardant
- Terminals: Pure tin plated, Lead free. Leads solderable per MIL-STD-750, Method 2026.
- . Polarity: Symbols molded or marked on body
- . Mounting position: Any



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at  $25\,^{\circ}\text{C}$  ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	SYM	KBJ	KBJ	KBJ	KBJ	KBJ	KBJ	KBJ	units
	BOL	10005	1001	1002	1004	1006	1008	1010	
Maximum Recurrent Peak Reverse Voltage	$V_{ m RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{ m RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	$V_{ m DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward rectified Output Current at $T_C$ =90°C	$I_{\mathrm{F(AV)}}$	10.0							A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rate load (JEDEC method)	$I_{ m FSM}$	175							A
Maximum Forward Voltage Drop per element at 10.0A DC	$V_{ m F}$	1.1							V
Maximum DC Reverse Current @T <sub>A</sub> =25°C at rated DC blocking voltage @T <sub>A</sub> =125°C	$I_{ m R}$	10.0 500.0							μА
I <sup>2</sup> t Rating for Fusing (t < 8.3ms)	<i>I</i> <sup>2</sup> t	127							A <sup>2</sup> Sec
Typical Junction Capacitance (Note 1)	$C_{ m J}$	55							pF
Typical Thermal Resistance (Note 2)	$R_{(JC)}$	2.5							°C/W
Storage Temperature	T <sub>STG</sub>	-55 to +150							°C
Operating Junction Temperature	$T_{ m J}$			-	55 to +15	0			°C

#### Note:

- 1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
- 2. Thermal Resistance from Junction to case per element units mounted on 30.0×30.0×1.6mm Aluminum plate heat-sink.

## RATING AND CHARACTERISTIC CURVES (KBJ10005 THRU KBJ1010)

